

FFP08S60S

Features

- High Speed Switching, $t_{rr} < 30\text{ns}$ @ $I_F=8\text{A}$
- High Reverse Voltage and High Reliability
- RoHS component

Applications

- General Purpose
- Switching Mode Power Supply
- Boost Diode in continuous mode power factor corrections
- Power switching circuits

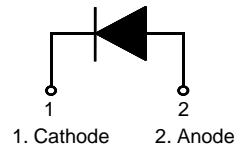
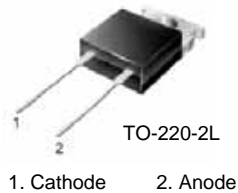
8A, 600V STEALTH™ II Rectifier

The FFP08S60S is STEALTH™ II rectifier with soft recovery characteristics. It is silicon nitride passivated ion-implanted epitaxial planar construction.

This device is intended for use as freewheeling or boost diode in switching power supplies and other power switching applications. Their low stored charge and hyperfast soft recovery minimize ringing and electrical noise in many power switching circuits reducing power loss in the switching transistors.



Pin Assignments



Absolute Maximum Ratings $T_C = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Value	Units
V_{RRM}	Peak Repetitive Reverse Voltage	600	V
V_{RWM}	Working Peak Reverse Voltage	600	V
V_R	DC Blocking Voltage	600	V
$I_{F(AV)}$	Average Rectified Forward Current @ $T_C = 115^\circ\text{C}$	8	A
I_{FSM}	Non-repetitive Peak Surge Current 60Hz Single Half-Sine Wave	80	A
T_J, T_{STG}	Operating Junction and Storage Temperature	- 65 to +150	$^\circ\text{C}$

Thermal Characteristics

Symbol	Parameter	Max	Units
$R_{\theta JC}$	Maximum Thermal Resistance, Junction to Case	2.5	$^\circ\text{C/W}$

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
F08S60S	FFP08S60STU	TO-220-2L	-	-	50

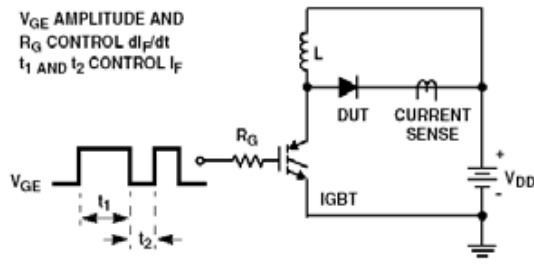
Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

Parameter	Conditions	Min.	Typ.	Max	Units	
V_{FM}^1	$I_F = 8\text{A}$	$T_C = 25^\circ\text{C}$	-	2.1	2.6	V
	$I_F = 8\text{A}$	$T_C = 125^\circ\text{C}$	-	1.6	-	V
I_{RM}^1	$V_R = 600\text{V}$	$T_C = 25^\circ\text{C}$	-	-	100	μA
	$V_R = 600\text{V}$	$T_C = 125^\circ\text{C}$	-	-	500	μA
t_{rr}	$I_F = 1\text{A}$, $di/dt = 100\text{A}/\mu\text{s}$, $V_R = 30\text{V}$	$T_C = 25^\circ\text{C}$	-	-	25	ns
t_{rr} I_{rr} S factor Q_{rr}	$I_F = 8\text{A}$, $di/dt = 200\text{A}/\mu\text{s}$, $V_R = 390\text{V}$	$T_C = 25^\circ\text{C}$	-	19	30	ns A - nC
t_{rr} I_{rr} S factor Q_{rr}	$I_F = 8\text{A}$, $di/dt = 200\text{A}/\mu\text{s}$, $V_R = 390\text{V}$	$T_C = 125^\circ\text{C}$	-	58	-	ns A - nC
W_{AVL}	Avalanche Energy (L = 40mH)	20	-	-	mJ	

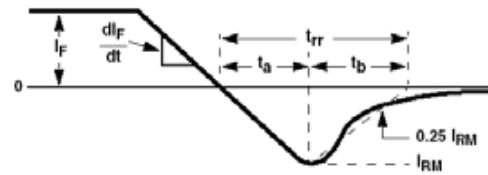
Notes:

1. Pulse : Test Pulse width = 300 μs , Duty Cycle = 2%

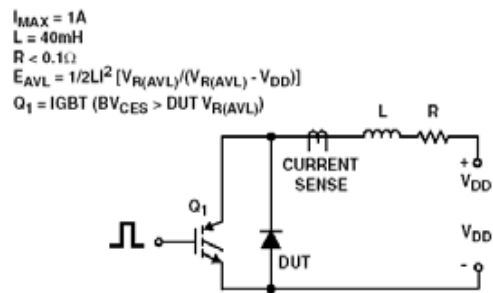
Test Circuit and Waveforms



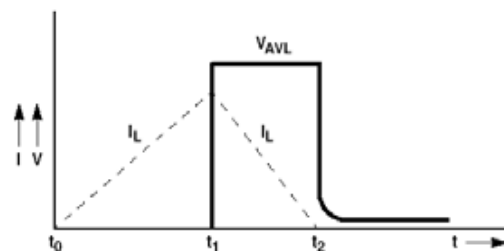
t_{rr} TEST CIRCUIT



t_{rr} WAVEFORMS AND DEFINITIONS



AVALANCHE ENERGY TEST CIRCUIT



AVALANCHE CURRENT AND VOLTAGE WAVEFORMS

Typical Performance Characteristics $T_c = 25^\circ\text{C}$ unless otherwise noted

Figure 1. Typical Forward Voltage Drop

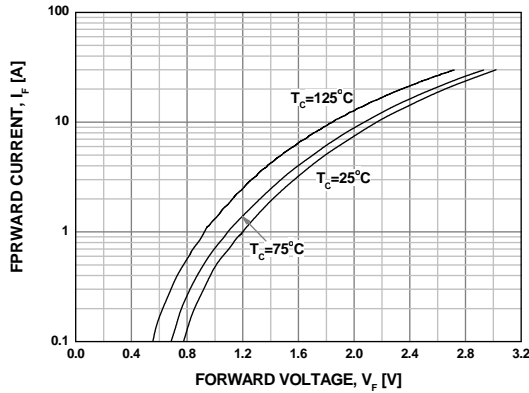


Figure 2. Typical Reverse Current

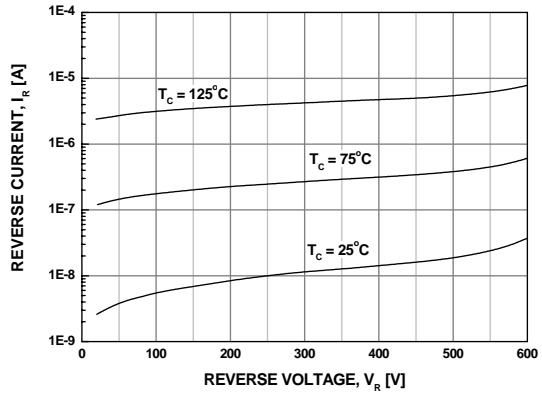


Figure 3. Typical Junction Capacitance

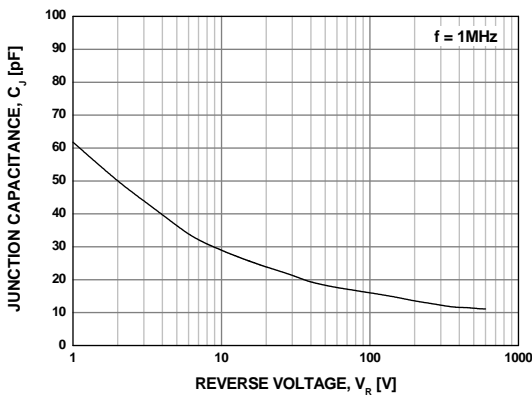


Figure 4. Typical Reverse Recovery Time

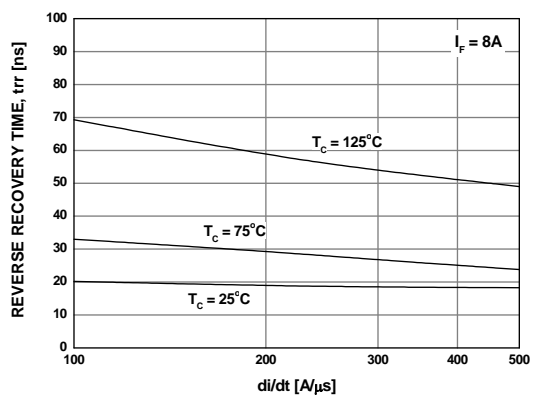


Figure 5. Typical Reverse Recovery Current

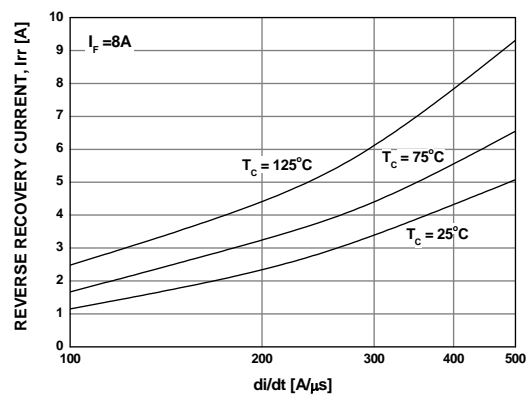
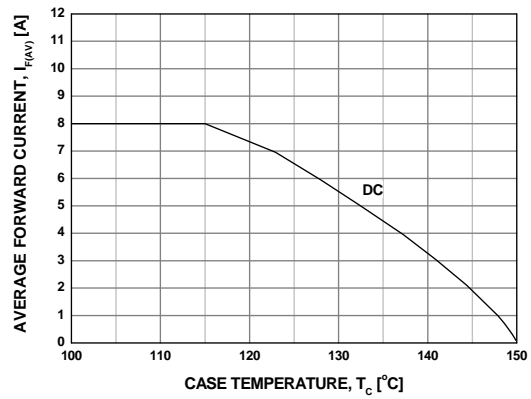
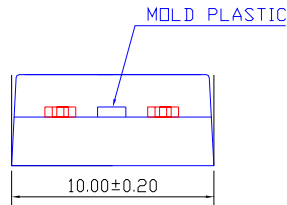
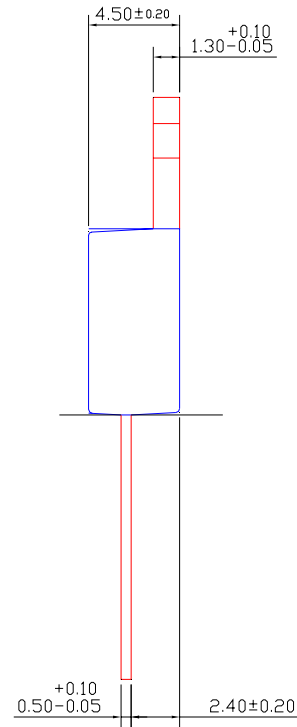
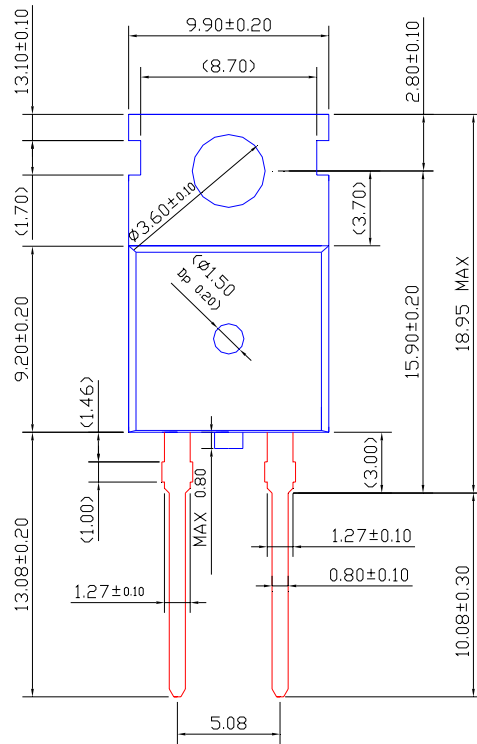


Figure 6. Forward Current Deration Curve



Mechanical Dimensions

TO-220-2L



NOTE


- 1. THESE DIMENSIONS DO NOT INCLUDE MOLD PROTRUSION.
- 2. () IS REFERENCE
- 3. [] IS ASS'Y OUT QUALITY

Dimensions in Millimeters



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